



# **OSM5XAHAE1E**

### VER.1

#### Features

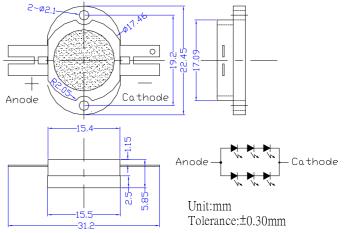
- · High-power LED
- · Long lifetime operation
- Typical viewing angle: 140deg
- · RoHS compliant
- Possible to attach to heat sink directly without using print circuit board.

## Applications

- · Indoor & outdoor lighting
- · Stage lighting
- · Reading lamps
- · Display cases, furniture illumination, marker
- · Architectural illumination
- · Spotlights

#### **■Outline Dimension**

(Ta=25°C)

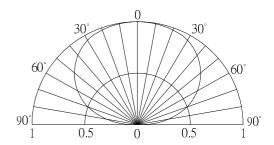


Tolerances are for reference only

## ■Absolute Maximum Rating

Item	Symbol	Value	Unit
DC Forward Current *1	$I_F$	1,400	mA
Pulse Forward Current*2	$I_{\mathrm{FP}}$	2,000	mA
Reverse Voltage	$V_R$	15	V
Power Dissipation*1	$P_{D}$	15,960	mW
Operating Temperature	Topr	-30 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40~ +100	$^{\circ}\!\mathbb{C}$
Lead Soldering Temperature	Tsol	260°€ /5sec	_

## **■**Directivity



<sup>\*1,</sup> Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

### ■ Electrical -Optical Characteristics (Ta=25°C)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage	$V_{\mathrm{F}}$	I <sub>F</sub> =1000mA	8.7	10	11.4	V
DC Reverse Current	$I_R$	$V_R=15V$	-	-	20	μΑ
Luminous Flux	Φν	I <sub>F</sub> =1000mA	670	765	-	lm
Color Temperature	CCT	I <sub>F</sub> =1000mA	-	3000	-	K
Chromaticity	X	I <sub>F</sub> =1000mA	-	0.45	-	
Coordinates*	у	I <sub>F</sub> =1000mA	1	0.41	1	
50% Power Angle	201/2	I <sub>F</sub> =1000mA	-	140	-	deg

Note: Don't drive at rated current more than 5s without heat sink for High Power series.

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<sup>\*2,</sup> Pulse width Max.10ms Duty ratio max 1/10

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## **■**Heat design

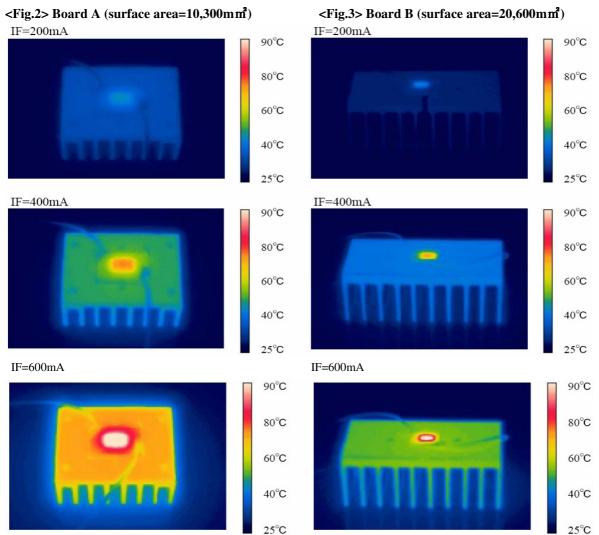
The following pictures show some measurements of mounted 5W Led on the heat sink for each board A and B (See Fig 1) with using thermograph to make an observation about heat distribution. Each boards is tested at various current conditions. As a result, LED needs larger heat sink as much as possible to reduce its own case temperature.

Fig. 1 Configuration pattern examples for board assembly

Board	LED power	Material	Surface area (mm²) Min.
A	5W	Al	10,300
В	10W	Al	20,600
С	25W	Al	51,500
D	50W	Al	103,000
Е	100W	Al	206,000
F	200W	Al	412,000
G	300W	Al	618,000

Above tested LED device is attached with adhesive sheet to the heatsink.

For reference's sake, Tj absolute maximum rating is defined at 115°C as a prerequisite on design process of 5W LED.



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